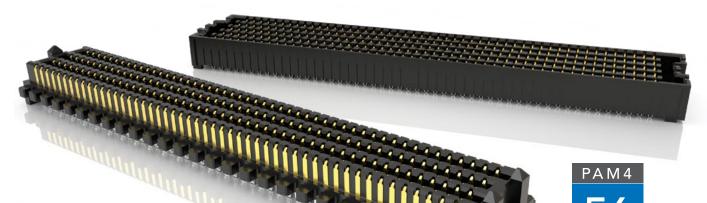
SEARCHY

HIGH-DENSITY OPEN-PIN-FIELD ARRAYS

(1.27 mm) .050" PITCH



FEATURES & BENEFITS

- · Maximum grounding & routing flexibility
- Up to 560 single-ended I/Os or 140 differential pairs
- Rugged Edge Rate® contacts
- Variety of designs and options: Right-Angle, Guide Posts, 85 Ω Elevated Risers, 85 Ω Tuned, Press-Fit and Press-Fit Right-Angle, Guide Post Field Termination Kits
- · Compatible with UMPT/UMPS for power/signal flexibility
- Cable mates (SEAC Series) and Jack Screw Standoffs (JSO Series) also available
- Standards: VITA 47, VITA 57.1 FMC, VITA 57.4 FMC+, VITA 74 VNX, PISMO™ 2
- Supports high-speed protocols such as Ethernet, PCI Express®,
 Fibre Channel & InfiniBand



(1.12 mm) .044" Nominal Wipe



Solder Charges

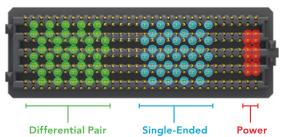


Power / Signal Applications





MAXIMUM GROUNDING & ROUTING FLEXIBILITY



KEY SPECIFICATIONS

PITCH	STACK HEIGHTS		INSULATOR MATERIAL	CONTACT MATERIAL	PLATING	OPERATING TEMP RANGE	CURRENT RATING	WORKING VOLTAGE	LEAD-FREE SOLDERABLE
1.27 mm x 1.27 mm	7 mm - 18.5 mm	40 - 560	Black LCP	Copper Alloy	Au or Sn over 50 μ" (1.27 μm) Ni	-55 °C to +125 °C	2.7 A per pin (10 adjacent pins powered) 7 mm stack height	240 VAC	Yes

Note: Some lengths, styles and options are non-standard, non-returnable



(1.27 mm) .050" PITCH • SEAM/SEAF SERIES



POSITIONS PER ROW

IFAD STYLE

PLATING OPTION

NO. OF ROWS

SOLDER





SEAM Terminal

SEAF Socket

-10, -15, -20, -30, -40, -50

SEAM & SEAF: -10 only available in -04 Row

SEAM: -15 only available in -04 Row with -02.0 Lead Style, and -10 Row with any Lead Style;

SEAF: -15 only available in -04 or -10 Row with -5.0 Lead Style

Specify

LEAD

STYLE

from

chart

-L = 10 μ" (0.25 μm) Gold on contact area, Matte Tin on solder tail

-S = 30 μ" (0.76 μm) Gold on contact area, Matte Tin on solder tail

-04

-05 -06

-08 -10

SEAM: -04, -05 & -06 (Rows not available with -06.5 Lead Style)

= Tin/Lead Alloy Solder Charge

-2 = Lead-Free Solder Charge

-A = Alignment Pin

–K Polyimide Film Pick & Place Pad

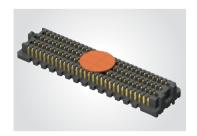
-TR = Tape & Reel

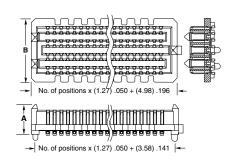
-FR

= Full Reel Tape & Reel (must order max. quantity per reel; contact Samtec for quantity breaks)

SEAM

Board Mates: SEAF, SEAFP Standoffs: JSO





LEAD STYLE	A	NO.
-02.0	(5.61) .221	_(
-03.0	(6.60) .260	-05,
-03.5	(7.11) .280	_(
-06.5	(10.16) .400	
-07.0	(10.59) .417	
-09.0	(12.60) .496	
-11.0	(14.61) .575	

. OF В 04 (7.06) .278 (9.60) .378 -06 (12.14) .478 (14.68) .578 -10

View complete specifications at: samtec.com?SEAM

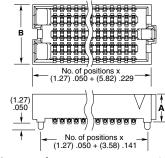
ALSO AVAILABLE

See website for 14 row option.

SEAF Board Mates: SEAM, SEAMP, SEAR, SEAMI Standoffs:

JSO





LEAD STYLE	A	NO. OF ROWS	В	
-05.0	(5.05) .199	-04	(5.66) .223	
-06.0	(6.05) .238	-05, -06	(8.20) .323	
-06.5	(6.55) .258	-08	(10.74) .423	
-07.5	(7.54) .297	-10	(13.28) .523	

View complete specifications at: samtec.com?SEAF

MATED HEIGHTS							
CEANALEAD CTVIE	SEAF LEAD STYLE						
SEAM LEAD STYLE	-05.0	-06.0	-06.5	-07.5			
-02.0	7 mm	8 mm	8.5 mm	9.5 mm			
-03.0	8 mm	9 mm	9.5 mm	10.5 mm			
-03.5	8.5 mm	9.5 mm	10 mm	11 mm			
-06.5	11.5 mm	12.5 mm	13 mm	14 mm			
-07.0	12 mm	13 mm	13.5 mm	14.5 mm			
-09.0	14 mm	15 mm	15.5 mm	16.5 mm			
-11.0	16 mm	17 mm	17.5 mm	18.5 mm			

STANDARDS VITA 47 VITA 57.1 FMC VITA 57.4 FMC+ VITA 74 VNX PISMO™2 Visit www.samtec.com/standards for more information.

IPC-A-610F and IPC J-STD-001F Class 3 solder joint.